Isola Laminate Systems

Product & Solutions Offering

Isola Laminate Systems' broad range of laminate, prepreg and foil products and solutions includes:

 PWB Substrates FR-4s

Composites

 Advanced PWB Substrates BT/Epoxy Polyimide

P97 & P27

Specialty Prepregs

- HDI Materials
- Signal Integrity Substrates
- Buried Passives Solutions
- Packaging Substrates

P97 & P27

Polyimide Laminate and Prepreg

Isola Laminate Systems offers a product line of polyimide-based prepreg and copper clad laminates for high temperature printed circuit applications. These products consist of a flame resistance polyimide resin system suitable for military, commercial or industrial electronic applications requiring superior performance and the utmost in thermal properties. They utilize a polyimide and thermoplastic blend resin, fully cured without the use of MDA (Methylene Dianiline). This results in a polymer with a high Tg without the characteristic difficulties of brittleness and low initial bond strength associated with traditional thermoset polyimides.

Performance and Processing Advantages

- High Tg 260°C TMA
 Greater thermal performance over epoxy-bismaleimide blends
- Maintains Bond Strength at High Temperature
- Tough Resin System

Improved processing due to less brittleness Less delamination from machining

- Flammability Rating V-0
- Non-MDA (Methylene Dianiline) Chemistry Meets all OSHA 1910.1050 requirements

Purchasing Information

Industry Approvals

IPC 4101/41

UL Recognized - GPY, UL File Number E41625

Standard Availability

Overall Thicknesses: 0.0025" to 0.125" Available in sheet or panel form **Copper Foil Cladding**: ½, 1, & 2 oz.

Options - Double-Treat, HTE, Copper-Invar-Copper

Prepregs: Available in roll or panel form Glass Styles -106, 1080, 2313, 2116, 7628

P97 Typical Laminate Properties, 0.008" [0.20mm]

Ordering Information

Contact your local representative or the Inside Sales Department in La Crosse, WI. Phone: 800/845-2904 or

608/784-6070 Fax: 800/344-1825 or 608/791-2428

Isola Laminate Systems Corp. 230 North Front Street La Crosse, WI 54601

For further information visit www.isolalaminatesystems.com

		IPC	P97	
PROPERTY	UNITS	4101	VALUE	CONDITIONING
Thickness	Inches [mm]	<0.030 [<0.78]	0.008 [0.20mm]	
Construction	-	-	2313/2116	
Retained Resin	%	-	47	
<u>Thermal</u>				
Tg, min - (TMA)	°C	250	260*	E-2/105
CTE x-axis	ppm/°C	-	17	Ambient to Tg
y-axis	ppm/°C	-	14	Ambient to Tg
z-axis	ppm/°C	-	54	Ambient to 288°C
Thermal Stress, 288 °C	seconds	10	900	E-2/105
Electrical Permittivity (DK), max. @				
1 MHz (2 Fluid Cell)	-	5.4	4.4	C-40/23/50
500 MHz (HP4291)	-	-	4.2	C-40/23/50
1 GHz (HP4291)	-	-	4.2	C-40/23/50
Loss Tangent (DF), max. @		-		
1 MHz (2 Fluid Cell) 500 MHz (HP4291)	-	0.035	0.014 0.012	C-40/23/50 C-40/23/50
1 GHz (HP4291)	-	-	0.014	C-40/23/50
Surface Resistivity, min.	megohms	1.0x10 ⁴	5.0x10 ⁵	C-96/35/90
Volume Resistivity, min.	megohms megohms-cm	$6.0x10^4$ $1.0x10^4$	1.6x10 ⁸ 3.4x10 ⁸	E-24/204 C-96/35/90
	megohms-cm	6.0x10 ⁴	1.3x10 ⁸	E-24/204
Electric Strength, min.	volts/mil [volts/mm]	737 [2.90x10 ⁴]	1340 [5.3x10 ⁴]	D-48/50
Arc Resistance, min.	seconds	120	130	D-48/50
<u>Physical</u>				
Peel Strength, min 1 oz	lb/in	-	9.1	Condition A
	[Kg/M] Ib/in	3.9	[162] 8.6	After Thermal Stress
	[Kg/M]	[70]	[152]	Arter Thermal Offess
	lb/in	3.35	7.2	E-1/170
Flammability	[Kg/M] -	[60] -	[130] V-0	UL94
Moisture Absorption, max.	%	1.0	.54*	D-24/23
* Marketial Thickness Target of 0.000#				·· - ·

^{*} Material Thickness Tested 0.028"

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